mXT640UD-CCUBHA1 1.0

maXTouch 640-node Touchscreen Controller
Product Brief

Description

The mXT640UD-CCUBHA1 1.0 uses a unique charge-transfer acquisition engine to implement Microchip's patented capacitive sensing method. Coupled with a state-of-the-art CPU, the entire touchscreen sensing solution can measure, classify and track a number of individual finger touches with a high degree of accuracy in the shortest response time. The mXT640UD-CCUBHA1 1.0 allows for both mutual and self capacitance measurements, with the self capacitance measurements being used to augment the mutual capacitance measurements to produce reliable touch information.

Functional Safety

- UL/IEC 60730 Class B support
- Self diagnostics at power-on and as periodic tests during operation
- Heartbeat (alive) signal output to host

maXTouch® Adaptive Sensing Technology

- Up to 32 X (transmit) lines and 20 Y (receive) lines for use by a touchscreen and/or key array
- A maximum of 640 nodes can be allocated to the touch sensor
- Touchscreen size of 9.7 inches (16:10 aspect ratio), assuming a sensor electrode pitch of 6.5 mm. Other sizes are possible with different electrode pitches and appropriate sensor material
- Multiple touch support with up to 16 concurrent touches tracked in real time

Keys

- Up to 32 nodes can be allocated as mutual capacitance sensor keys in addition to the touchscreen, defined as 1 key array (subject to availability of X and Y lines and other configurations)
- Support for up to 3 mutual capacitance Generic Keys as an alternative to the touchscreen key array (subject to other configurations)
- Adjacent Key Suppression (AKS) technology is supported for false key touch prevention

Touch Sensor Technology

- Discrete/out-cell support including glass and PET film-based sensors
- On-cell/touch-on display support including TFT, LCD (ITPS, IPS) and OLED
- Synchronization with display refresh timing capability
- Support for standard (for example, Diamond) and proprietary sensor patterns (review of designs by Microchip or a Microchip-qualified touch sensor module partner is recommended)

Front Panel Material and Design

- Works with PET or glass, including curved profiles (configuration and stack-up to be approved by Microchip or a Microchip-qualified touch sensor module partner)
- 10 mm glass (or 5 mm PMMA) with bare finger (dependent on sensor size, touch size, configuration and stack-up)
- 6 mm glass (or 3 mm PMMA) with multi-finger 5 mm glove (2.7 mm PMMA equivalent) (dependent on sensor size, touch size, configuration and stack-up)
- Support for non-rectangular sensor designs (for example, circular, rounded or with cutouts)

Touch Performance

- Moisture/Water Compensation
  - No false touch with condensation or water drop up to 22 mm diameter
  - One-finger tracking with condensation or water drop up to 22 mm diameter
- Mutual capacitance and self capacitance measurements supported for robust touch detection
- P2P mutual capacitance measurements supported for extra sensitive multi-touch sensing
- Noise suppression technology to combat ambient and power-line noise
  - Up to 240 V_{PP} between 1 Hz and 1 kHz sinusoidal waveform (no touches)
  - IEC 61000-4-6, 10 Vrms, Class A (normal touch operation) conducted noise immunity
- Stylus Support
  - Supports passive stylus with 1.5 mm contact diameter, subject to configuration, stack-up, and sensor design

- Burst Frequency
  - Flexible and dynamic Tx burst frequency selection to reduce EMC disturbance
  - Configurable Tx waveform shaping to reduce emissions
- Scan Speed
  - Typical report rate for 10 touches ≥90 Hz (subject to configuration)
  - Initial touch latency <25 ms for first touch from idle (subject to configuration)
  - Configurable to allow for power and speed optimization

On-chip Gestures

- Reports one-touch and two-touch gestures

Enhanced Algorithms

- Lens bending algorithms to remove display noise
- Touch suppression algorithms to remove unintentional large touches, such as palm
- Palm Recovery Algorithm for quick restoration to normal state

Data Store

- Up to 64 bytes of user's custom data (not CRC checksummed)

Power Saving

- Programmable timeout for automatic transition from Active to Idle state
- Pipelined analog sensing detection and digital processing to optimize system power efficiency

Application Interfaces

- I^2C client interface for main communication with the device, with support for Standard mode (up to 100 kHz), Fast mode (up to 400 kHz), Fast-mode Plus (up to 1 MHz), High Speed mode (up to 3.4 MHz)
- Optional secondary SPI interface for separate messaging (up to 8 MHz)
- Two separate interrupts to indicate when messages are available on the corresponding interfaces
- Additional Hardware Debug Interface to read the raw data for tuning and debugging purposes

Power Supply

- Digital (Vdd) 3.3V nominal
- Digital I/O (VddIO) 3.3V nominal
- Analog (AVdd) 3.3V nominal
- High voltage internal X line drive (XVdd) 6.6V or 9.9V with internal voltage pump

Package

- 88-ball UFBGA 6 × 6 × 0.6 mm, 0.5 mm pitch

Operating Temperature

- −40°C to +105°C

Design Services

- Review of device configuration, stack-up and sensor patterns

PIN CONFIGURATION

88-ball UFBGA

	1	2	3	4	5	6	7	8	9	10	11
A	AVDD	DS0	Y18	Y16	Y14		Y8	Y6	Y4	Y2	Y0
B	X18		Y19	Y17	Y15		Y7	Y5	Y3		AVDD
C	X20	X19		GND	Y13		Y9	Y1		X0	X1
D	X22	X21	X17		Y12	Y11	Y10		GND	X2	X3
E	X24	X23	X25	X26				X7	X6	X4	X5
F				X27				X8			
G	X30	X31	X29	X28				X9	X10	X12	X11
H	RESV	RESV	EXTCAP1		SCK	$\overline{\text{TEST}}$	$\overline{\text{CHG\_I2C}}$		GND	X14	X13
J	EXTCAP0	EXTCAP3		GND	$\overline{\text{SS}}$		RESV	MOSI		X16	X15
K	EXTCAP2		VDDIO	$\overline{\text{RESET}}$	MISO		$\overline{\text{CHG\_SPI}}$	DBG_DATA GPIO2	GKEYY2		GKEYX0
L	XVDD	VDD	VDDCORE	SCL	SDA		SYNC GPIO0	DBG_CLK GPIO1	GKEYY1	GKEYY0	XVDD

Top View

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mXT640UD-CCUBHA1 1.0

1.0   PACKAGING INFORMATION

1.1   Package Marking Information

1.1.1   88-BALL UFBGA

Ball A1 ID →

Abbreviation of Part Number →

Date (Year and Week) and Die Revision →

Lot Traceability Code →

MXT640UD

CCU

yywwR   CCC

yywwNNN

← Country Code
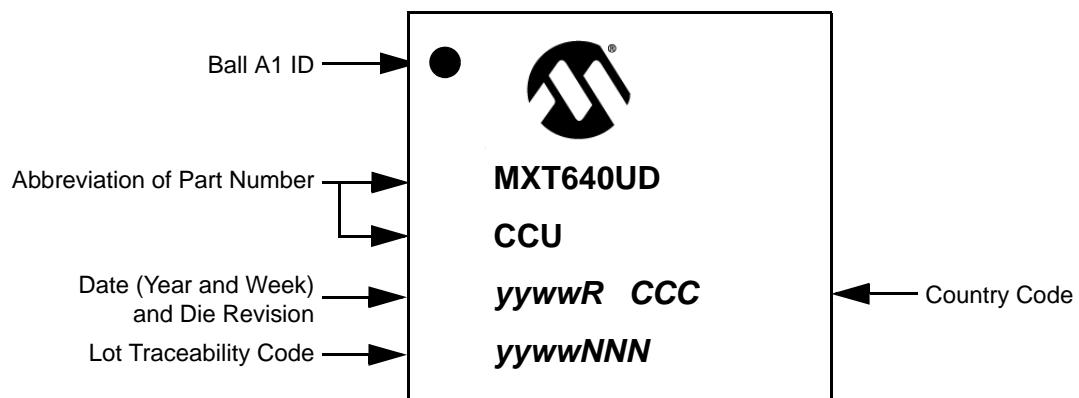
1.1.2   ORDERABLE PART NUMBERS

The product identification system for maXTouch devices is described in "Product Identification System" on page 9. That section also lists example part numbers for the device.

1.2   Package Details

88-Ball Ultra Thin Fine Pitch Ball Grid Array (BVB) - 6x6x0.6 mm Body [UFBGA]
Atmel Legacy Global Package Code CJM

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

TOP VIEW

SIDE VIEW

BOTTOM VIEW

Microchip Technology Drawing C04-21158 Rev A Sheet 1 of 2
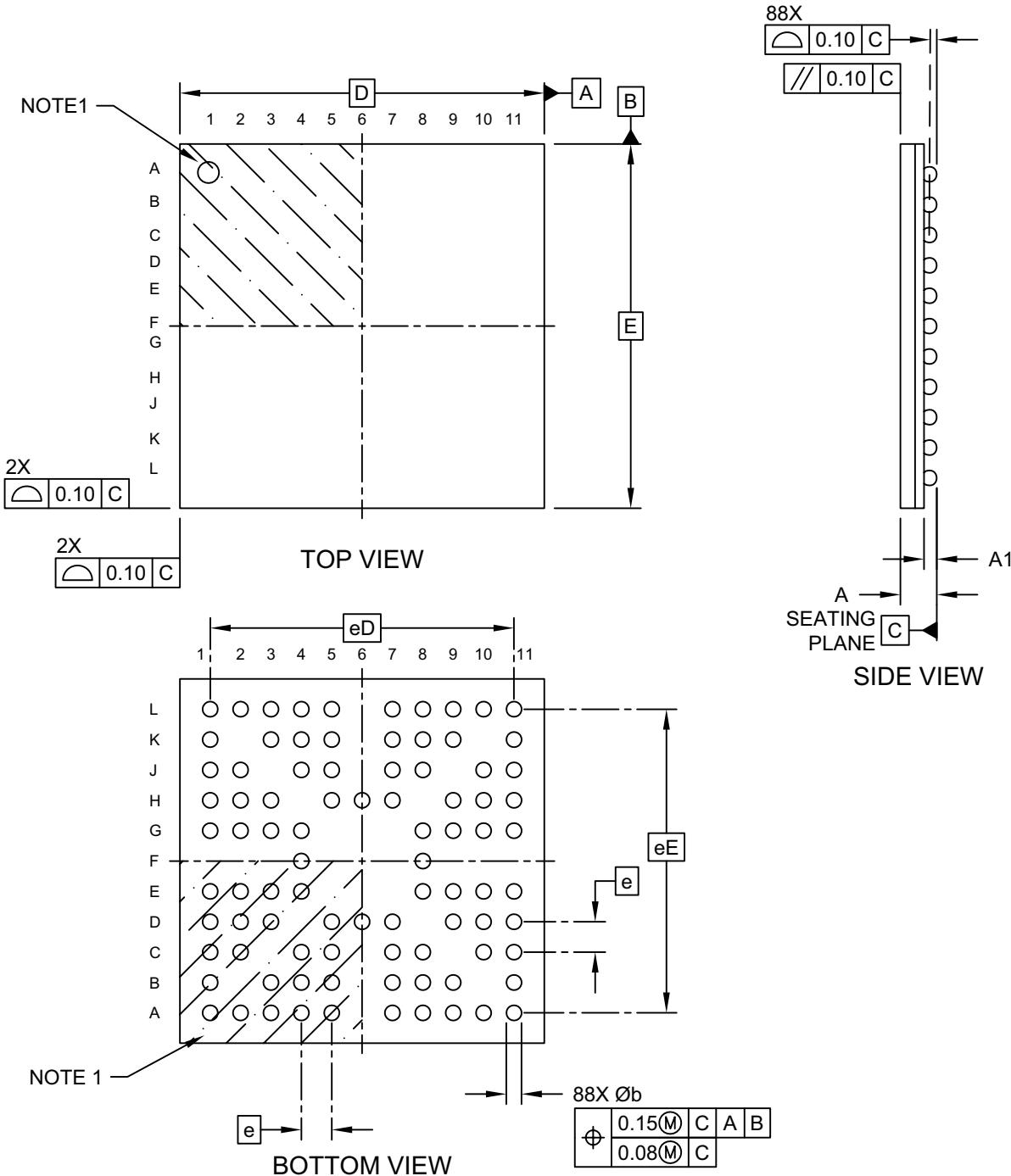
88-Ball Ultra Thin Fine Pitch Ball Grid Array (BVB) - 6x6x0.6 mm Body [UFBGA]
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Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging
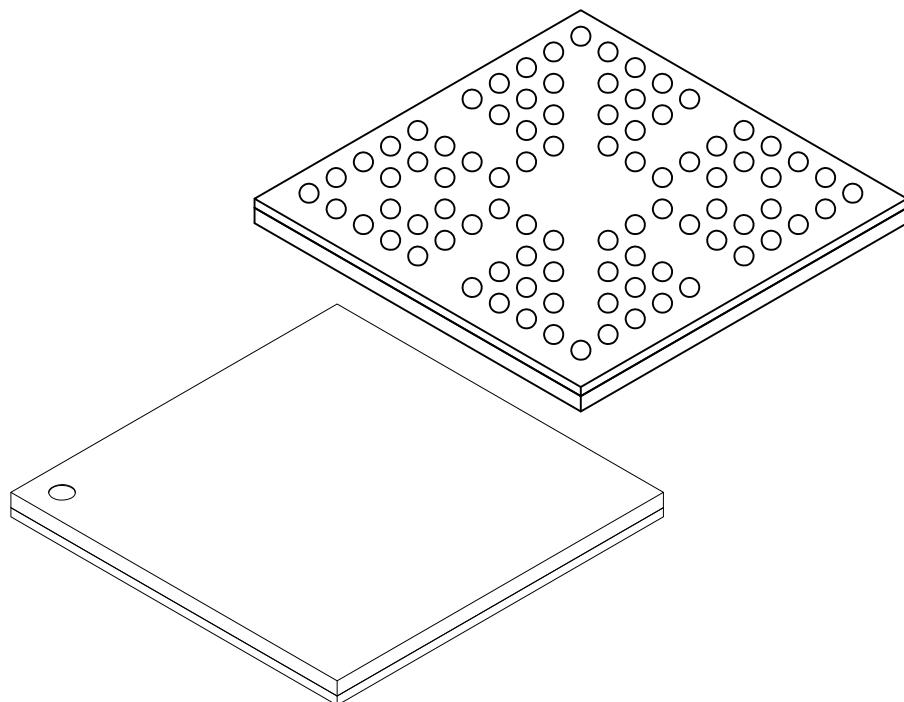
	Units	MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Terminals	N		88	
Pitch	e		0.50 BSC	
Overall Terminal Spacing	eD		5.00 BSC	
Overall Terminal Spacing	eE		5.00 BSC	
Overall Height	A	–	–	0.60
Standoff	A1	0.11	–	0.21
Overall Length	D		6.00 BSC	
Overall Width	E		6.00 BSC	
Terminal Diameter	b	0.22	0.25	0.28

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Dimensioning and tolerancing per ASME Y14.5M
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.
   REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-21158 Rev A Sheet 2 of 2

Product Brief

88-Ball Ultra Thin Fine Pitch Ball Grid Array (BVB) - 6x6x0.6 mm Body [UFBGA]
Atmel Legacy Global Package Code CJM

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging
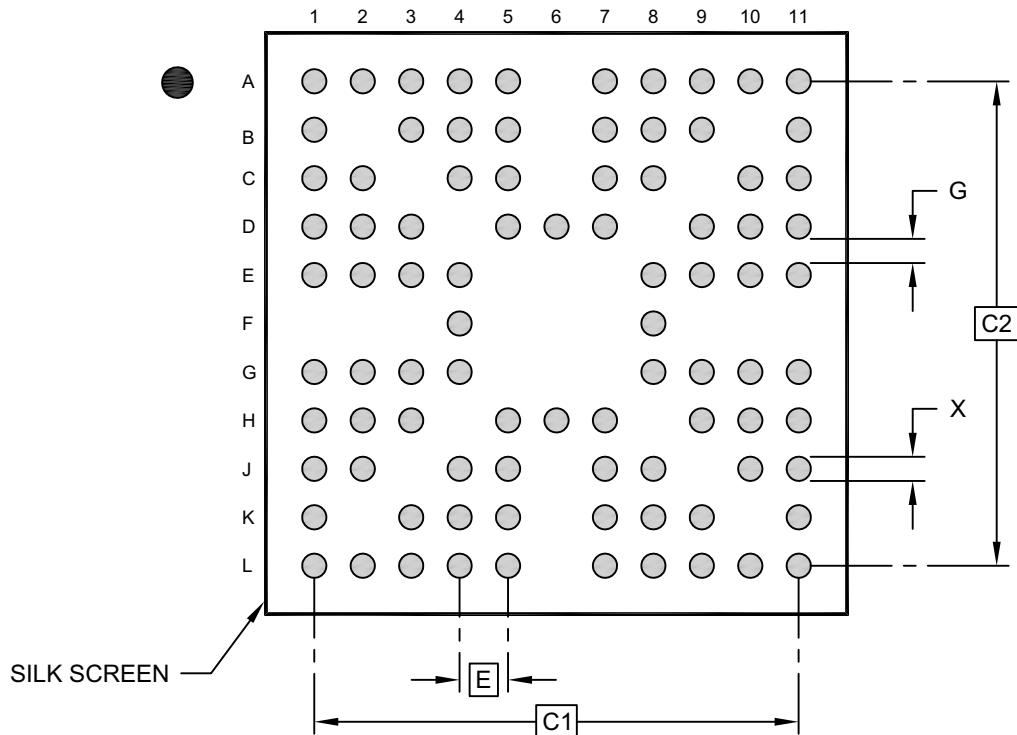
RECOMMENDED LAND PATTERN

	Units	MILLIMETERS		
	Dimension Limits	MIN	NOM	MAX
Contact Pitch	E		0.50 BSC	
Overall Contact Pitch	C1		5.00 BSC	
Overall Contact Pitch	C2		5.00 BSC	
Contact Pad Diameter	X			0.28
Contact Pad to Contact Pad	G	0.25		

Notes:
1. Dimensioning and tolerancing per ASME Y14.5M

    BSC: Basic Dimension. Theoretically exact value shown without tolerances.
2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-23158 Rev A

APPENDIX A: REVISION HISTORY

Revision A (September 2021)

Initial edition for firmware revision 1.0.AA – Release

Product Brief

PRODUCT IDENTIFICATION SYSTEM

The table below gives details on the product identification system for maXTouch devices. See "Orderable Part Numbers" below for example part numbers for the mXT640UD-CCUBHA1.

To order or obtain information, for example on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	–XXX	[X]	[X]	[XXX]
Device	Package	Temperature Range	Tape and Reel Option	Pattern

Device:		Base device name	
Package:	CCU	=	UFBGA (Ultra Thin Fine-pitch Ball Grid Array)
	C2	=	UFBGA (Ultra Thin Fine-pitch Ball Grid Array)
	NH	=	UFBGA (Ultra Thin Fine-pitch Ball Grid Array)
	C4	=	X1FBGA (Extra Thin Fine-pitch Ball Grid Array)
	MA	=	XQFN (Super Thin Quad Flat No Lead Sawn)
	MA5	=	XQFN (Super Thin Quad Flat No Lead Sawn)
Temperature Range:	U	=	–40°C to +85°C (Grade 3)
	T	=	–40°C to +85°C (Grade 3)
	B	=	–40°C to +105°C (Grade 2)
Tape and Reel Option:	*Blank*	=	Standard Packaging (Tube or Tray)
	R	=	Tape and Reel **(1)**
Pattern:			Extension, QTP, SQTP, Code or Special Requirements (Blank Otherwise)

Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. See "Orderable Part Numbers" below or check with your Microchip Sales Office for package availability with the Tape and Reel option.

Orderable Part Numbers

Orderable Part Number	Firmware Revision	Description
ATMXT640UD-CCUBHA1 (Supplied in trays)	1.0.AA	88-ball UFBGA 6 × 6 × 0.6 mm, RoHS compliant
ATMXT640UD-CCUBRHA1 (Supplied in tape and reel)		

NOTES:

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